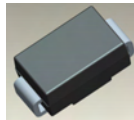


## Features

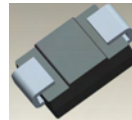
- Glass Passivated Die Construction
- Super-Fast Recovery Time For High Efficiency
- Surge Overload Rating to 50A Peak
- Ideally Suited for Automated Assembly
- **Lead Free Finish/RoHS Compliant (Note 1)**
- **Green Molding Compound (No Halogen and Antimony) (Note 2)**

## Mechanical Data

- Case: SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 **e3**
- Polarity: Cathode Band or Cathode Notch
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.093 grams (approximate)



Top View



Bottom View

## Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	400	V
Working Peak Reverse Voltage	$V_{RWM}$		
DC Blocking Voltage (Note 6)	$V_R$		
RMS Reverse Voltage	$V_{R(RMS)}$	280	V
Average Rectified Output Current @ $T_T = 110^\circ\text{C}$	$I_O$	2.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	$I_{FSM}$	50	A

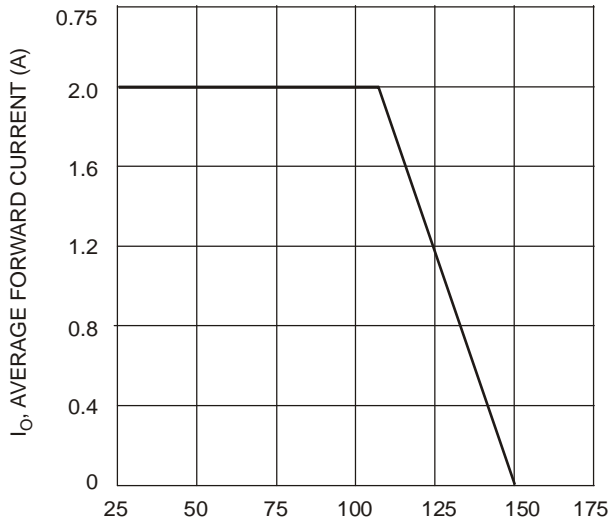
## Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Terminal (Note 3)	$R_{\theta JT}$	20	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	$^\circ\text{C}$

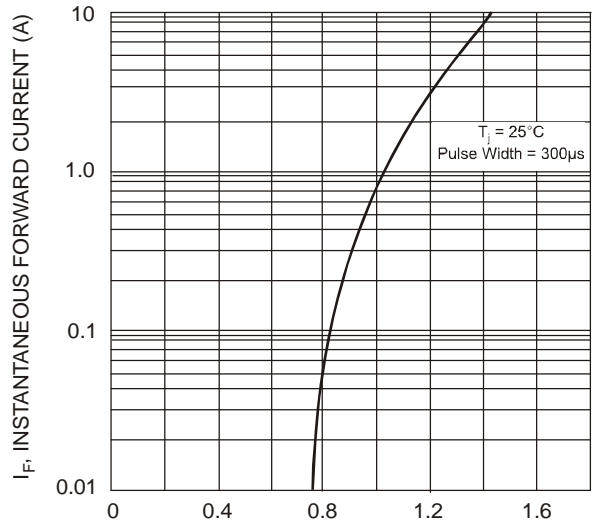
## Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Forward Voltage @ $I_F = 2.0\text{A}$	$V_{FM}$	1.25	V
Peak Reverse Current @ $T_A = 25^\circ\text{C}$	$I_{RM}$	5.0	$\mu\text{A}$
at Rated DC Blocking Voltage (Note 6) @ $T_A = 125^\circ\text{C}$		350	
Reverse Recovery Time (Note 5)	$t_{rr}$	35	ns
Typical Capacitance (Note 4)	$C_T$	25	pF

- Notes:
1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
  2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
  3. Unit mounted on PC board with  $5.0\text{ mm}^2$  (0.013 mm thick) copper pads as heat sink.
  4. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
  5. Measured with  $I_F = 0.5\text{A}$ ,  $I_R = 1.0\text{A}$ ,  $I_{rr} = 0.25\text{A}$ . See Figure 5.
  6. Short duration pulse test used to minimize self-heating effect



$T_T$ , TERMINAL TEMPERATURE (°C)  
Fig. 1 Forward Current Derating Curve



$V_F$ , INSTANTANEOUS FORWARD VOLTAGE (V)  
Fig. 2 Typical Forward Characteristics

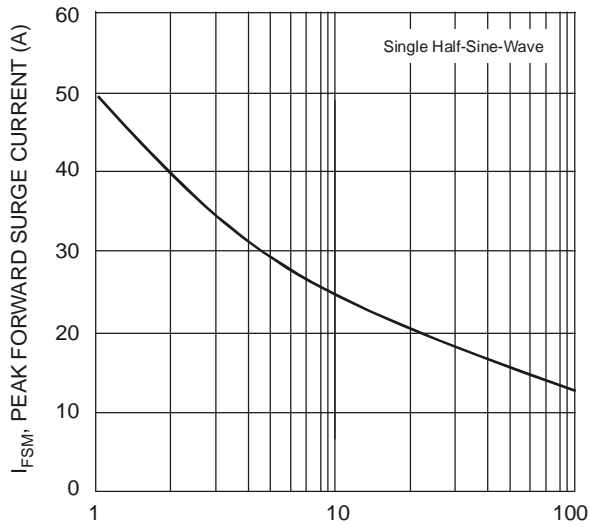


Fig. 3 Surge Current Derating Curve

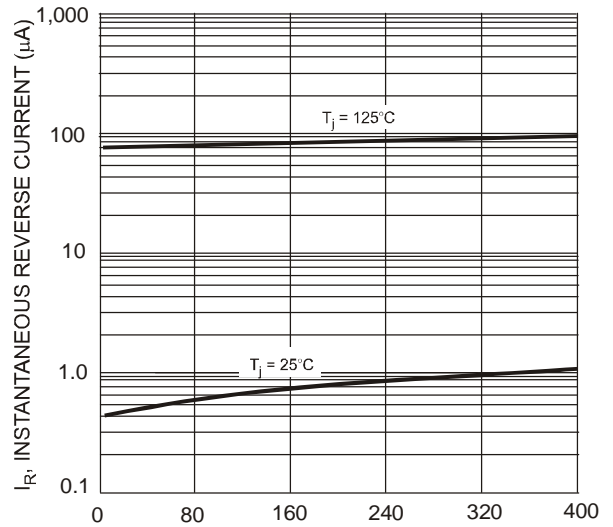
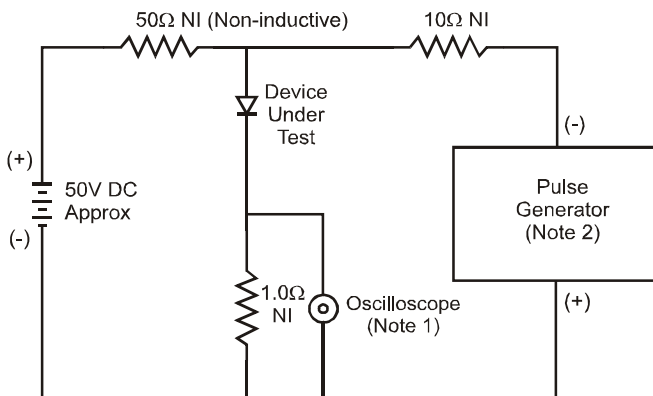
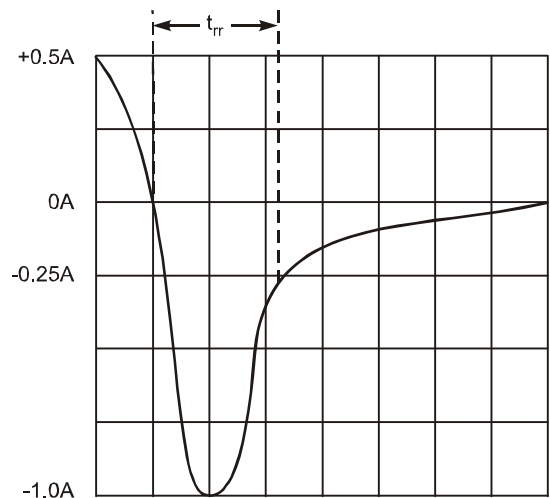


Fig. 4 Typical Reverse Characteristics



- Notes:  
 1. Rise Time = 7.0ns max. Input Impedance = 1.0MΩ, 22pF.  
 2. Rise Time = 10ns max. Input Impedance = 50Ω.



Set time base for 50/100 ns/cm

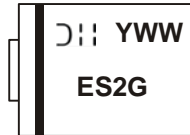
Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

**Ordering Information** (Note 7)

Part Number	Case	Packaging
ES2G-13-F	SMB	3000/Tape & Reel

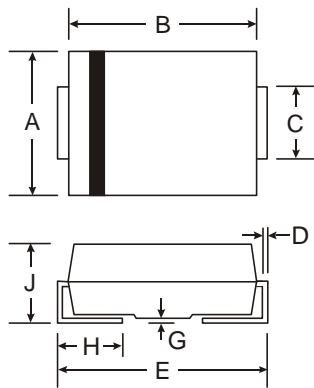
Notes: 7. For packaging details, go to our website at <http://www.diodes.com>.

**Marking Information**



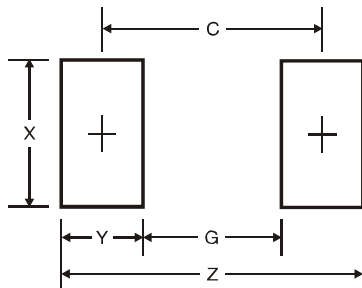
ES2G = Product type marking code  
 DI = Manufacturers' code marking  
 YWW = Date code marking  
 Y = Last digit of year (ex: 2 for 2002)  
 WW = Week code (01 to 53)

**Package Outline Dimensions**



SMB		
Dim	Min	Max
A	3.30	3.94
B	4.06	4.57
C	1.96	2.21
D	0.15	0.31
E	5.00	5.59
G	0.05	0.20
H	0.76	1.52
J	2.00	2.50
All Dimensions in mm		

**Suggested Pad Layout**



SMB Dimensions	Value (in mm)
Z	6.7
G	1.8
X	2.3
Y	2.5
C	4.3

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